

# **LET9006**

## **RF POWER TRANSISTORS**

# Ldmos Enhanced Technology in Plastic Package

TARGET DATA

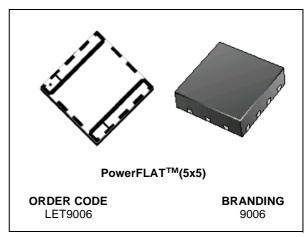
N-CHANNEL ENHANCEMENT-MODE LATERAL MOSFETs

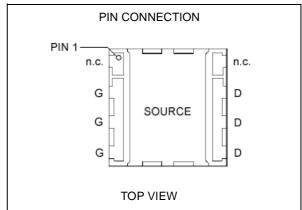
- EXCELLENT THERMAL STABILITY
- COMMON SOURCE CONFIGURATION
- P<sub>OUT</sub> = 6 W with 17 dB gain @ 960 MHz / 26V
- NEW LEADLESS PLASTIC PACKAGE
- ESD PROTECTION
- SUPPLIED IN TAPE & REEL OF 3K UNITS

#### **DESCRIPTION**

The LET9006 is a common source N-Channel, enhancement-mode lateral Field-Effect RF power transistor. It is designed for high gain, broad band commercial and industrial applications. It operates at 26 V in common source mode at frequencies up to 1 GHz. LET9006 boasts the excellent gain, linearity and reliability of ST's latest LDMOS technology mounted in the innovative leadless SMD plastic package, PowerFLAT™.

It is ideal for digital cellular BTS applications requiring high linearity.





### ABSOLUTE MAXIMUM RATINGS (T<sub>CASE</sub> = 25 °C)

| Symbol               | Parameter                           | Value       | Unit |
|----------------------|-------------------------------------|-------------|------|
| V <sub>(BR)DSS</sub> | Drain-Source Voltage                | 65          | V    |
| V <sub>GS</sub>      | Gate-Source Voltage                 | -0.5 to +15 | V    |
| I <sub>D</sub>       | Drain Current                       | 1           | Α    |
| P <sub>DISS</sub>    | Power Dissipation (@ Tc = 70°C)     | 16          | W    |
| Tj                   | Max. Operating Junction Temperature | 150         | °C   |
| T <sub>STG</sub>     | Storage Temperature                 | -65 to +150 | °C   |

### THERMAL DATA

| $R_{th(j-c)}$ | Junction -Case Thermal Resistance | 5 | °C/W | l |
|---------------|-----------------------------------|---|------|---|

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# ELECTRICAL SPECIFICATION (T<sub>CASE</sub> = 25 °C)

### **STATIC**

| Symbol               |                        | Test Condition          | ons       | Min. | Тур. | Max. | Unit |
|----------------------|------------------------|-------------------------|-----------|------|------|------|------|
| V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0 V  | $I_D = 1 \text{ mA}$    |           | 65   |      |      |      |
| I <sub>DSS</sub>     | V <sub>GS</sub> = 0 V  | V <sub>DS</sub> = 26 V  |           |      |      | 1    | μΑ   |
| I <sub>GSS</sub>     | V <sub>GS</sub> = 5 V  | V <sub>DS</sub> = 0 V   |           |      |      | 1    | μΑ   |
| V <sub>GS(Q)</sub>   | V <sub>DS</sub> = 26 V | I <sub>D</sub> = TBD    |           | 2.0  |      | 5.0  | V    |
| V <sub>DS(ON)</sub>  | V <sub>GS</sub> = 10 V | I <sub>D</sub> = 0.5 A  |           |      |      | 0.9  | V    |
| 9FS                  | V <sub>DS</sub> = 10 V | I <sub>D</sub> = 800 mA |           |      | TBD  |      | mho  |
| C <sub>ISS</sub>     | V <sub>GS</sub> = 0 V  | V <sub>DS</sub> = 26 V  | f = 1 MHz |      | TBD  |      | pF   |
| Coss                 | V <sub>GS</sub> = 0 V  | V <sub>DS</sub> = 26 V  | f = 1 MHz |      | TBD  |      | pF   |
| C <sub>RSS</sub>     | V <sub>GS</sub> = 0 V  | $V_{DS} = 26 \text{ V}$ | f = 1 MHz |      | TBD  |      | pF   |

### **DYNAMIC** (f = 960 MHz)

| Symbol                        | Test Conditions   | Min. | Тур. | Max. | Unit |
|-------------------------------|---|------|------|------|------|
| Pout <sup>(1)</sup>           | $V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$                          | 7    | 8    |      | W    |
| η <sub>D</sub> <sup>(1)</sup> | $V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$ $P_{OUT} = 6 \text{ W}$  | 55   | 65   |      | %    |
| Load<br>mismatch              | $V_{DD}$ = 26 V $I_{DQ}$ = TBD $P_{OUT}$ = 6 W ALL PHASE ANGLES |      |      | 10:1 | VSWR |

(1) 1 dB Compression point

### **DYNAMIC** (*f* = 920 - 960 MHz)

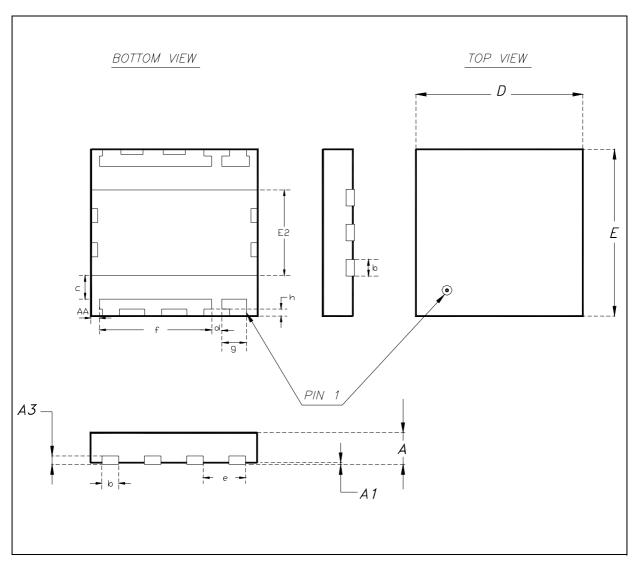
| Symbol              | Test Conditions   | Min. | Тур. | Max. | Unit |
|---------------------|---|------|------|------|------|
| Pout <sup>(1)</sup> | $V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$                              | 6    | 7    |      | W    |
| G <sub>P</sub>      | V <sub>DD</sub> = 26 V I <sub>DQ</sub> = TBD P <sub>OUT</sub> = 6 W | 17   |      |      | dB   |
| $\eta_D^{(1)}$      | $V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$ $P_{OUT} = 6 \text{ W}$      | 55   | 60   |      | %    |

(1) 1 dB Compression point

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## **PowerFLAT™ MECHANICAL DATA**

| DIM. |      | mm   |      |       | Inch  |       |
|------|------|------|------|-------|-------|-------|
| DIN. | MIN. | TYP. | MAX  | MIN.  | TYP.  | MAX   |
| Α    |      | 0.90 | 1.00 |       | 0.035 | 0.039 |
| A1   |      | 0.02 | 0.05 |       | 0.001 | 0.002 |
| А3   |      | 0.24 |      |       | 0.009 |       |
| AA   | 0.15 | 0.25 | 0.35 | 0.006 | 0.01  | 0.014 |
| b    | 0.43 | 0.51 | 0.58 | 0.017 | 0.020 | 0.023 |
| С    | 0.64 | 0.71 | 0.79 | 0.025 | 0.028 | 0.031 |
| D    |      | 5.00 |      |       | 0.197 |       |
| d    |      | 0.30 |      |       | 0.011 |       |
| E    |      | 5.00 |      |       | 0.197 |       |
| E2   | 2.49 | 2.57 | 2.64 | 0.098 | 0.101 | 0.104 |
| е    |      | 1.27 |      |       | 0.050 |       |
| f    |      | 3.37 |      |       | 0.132 |       |
| g    |      | 0.74 |      |       | 0.03  |       |
| h    |      | 0.21 |      |       | 0.008 |       |



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